

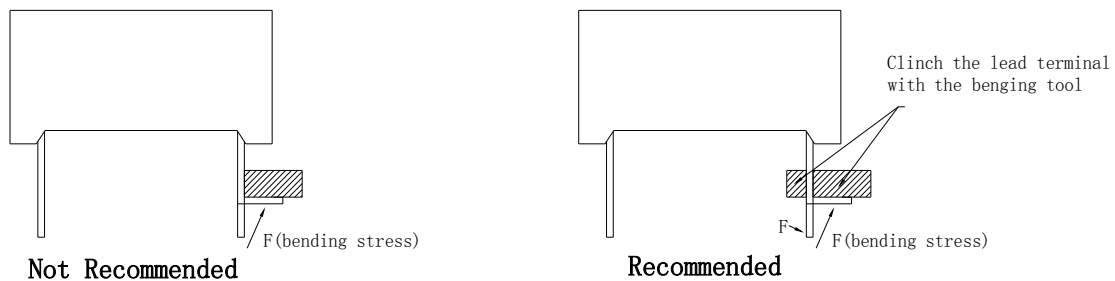
1. Terms and Conditions for the Usage of This Document

- 1.1 The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 1.2 The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 1.3 When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, LuckyLight will not be responsible for any subsequent issues.
- 1.4 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with LuckyLight representative for further assistance.
- 1.5 The contents and information of this document may not be reproduced or re-transmitted without permission by LuckyLight.
- 1.6 Over-current-proof
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).
- 1.7 Storage
 - 1.7.1 Before opening the package, the LEDs should be kept at 30°C or less and 80%RH or less.
 - 1.7.2 The LEDs should be used within a year.
 - 1.7.3 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.

2. Through-hole Display Mounting Method

2.1 Lead Forming:

- 2.1.1 Do not bend the component leads by hand without proper tools.
- 2.2.2 The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

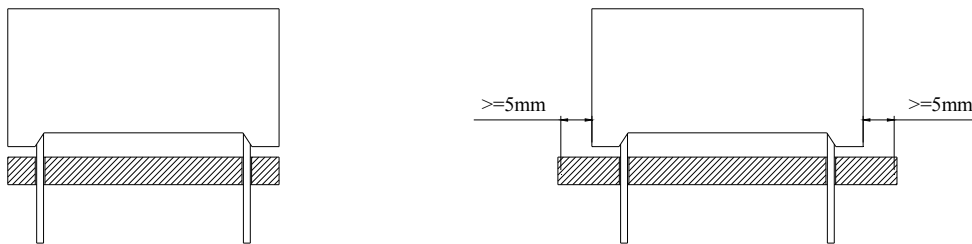


2.2 Installation:

- 2.2.1 The installation process should not apply stress to the lead terminals.
- 2.2.2 When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

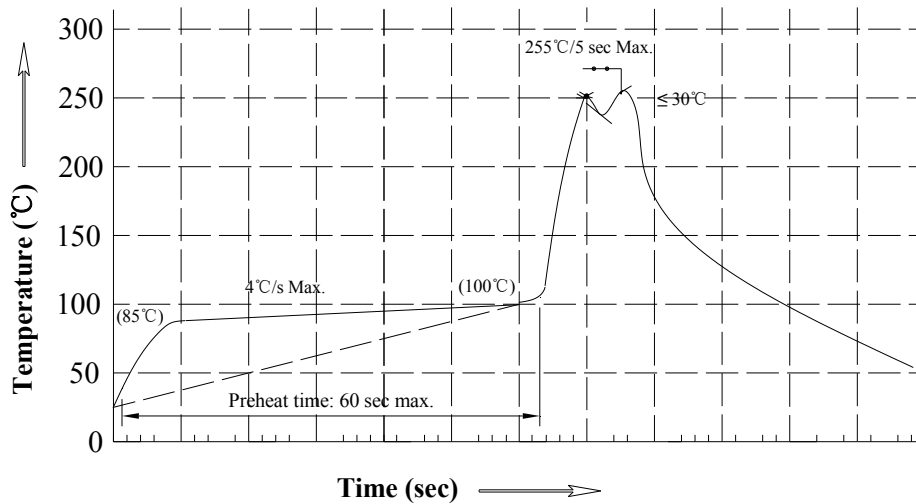


2.2.3 The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



2.3 Soldering General Notes:

Recommended Wave Soldering Profiles



Notes:

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C.
- Peak wave soldering temperature between 245°C~255°C for 3 sec (5 sec max).
- Do not apply stress to the epoxy resin while the temperature is above 85°C.
- Fixtures should not incur stress on the component when mounting and during soldering process.
- SAC 305 solder alloy is recommended.
- No more than one wave soldering pass.

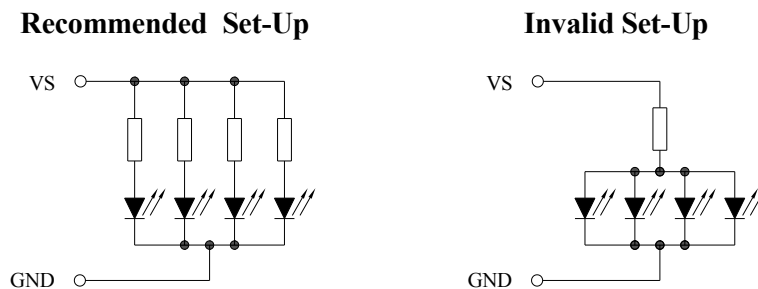
- g. During wave soldering, the PCB top-surface temperature should be kept below 105°C.
- h. Through-hole displays are incompatible with reflow soldering.
- i. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Luckylight for compatibility.

3. Cleaning

- 3.1 Mild “no-clean” fluxes are recommended for use in soldering.
- 3.2 If cleaning is required, Luckylight recommends to wash components with water only.
Do not use harsh organic solvents for cleaning because they may damage the plastic parts.
- 3.3 The cleaning process should take place at room temperature and the devices should not be washed for more than one minute.
- 3.4 When water is used in the cleaning process, immediately remove excess moisture from the component with forced-air drying afterwards.

4. Circuit Design Notes

- 4.1 Protective current-limiting resistors may be necessary to operate the LEDs within the specified range.
- 4.2 LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



- 4.3 The driving circuit should be designed to protect the LED against reverse voltages and transient voltage spikes when the circuit is powered up or shut down.
- 4.4 The safe operating current should be chosen after considering the maximum ambient temperature of the operating environment.
- 4.5 Prolonged reverse bias should be avoided, as it could cause metal migration, leading to an increase in leakage current or causing a short circuit.

5. Using Conditions

- 5.1 Recommend to use the display under constant current conditions, and brightness uneven phenomenon may happen if used under constant voltage conditions.
- 5.2 Make sure the input current and input voltage are correct for each segment and decimal dot, a current-limiting resistance is needed for each segment and decimal dot too.
- 5.3 Keep the products out of corrosive atmosphere.
- 5.4 All assembly and testing equipments should be with well ground connection.
- 5.5 Input current: dynamic current 3-10mA per segment or decimal dot.

5.6 ESD preventive measures are needed for blue, pure-green and white emitted color Displays.

5.7 Don't put heavy articles on the surface of displays to avoid surface ink peel off.

5.8 Please avoid to contact the Bin-code area when picking up the displays, otherwise the sweet may caused Bin-code vague.

5.9 Don't crash the display with other articals or drop on the ground to avoid damages during picking up.